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HCPL-817

Phototransistor Optocoupler High Density Mounting Type

AVAGO TECHNOLOGIES

Data Sheet

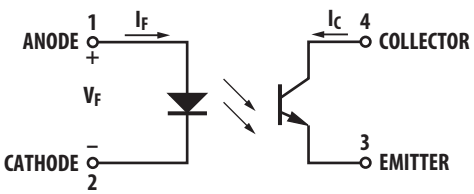
Lead (Pb) Free
RoHS 6 fully compliant

RoHS 6 fully compliant options available;
-xxxE denotes a lead-free product

Description

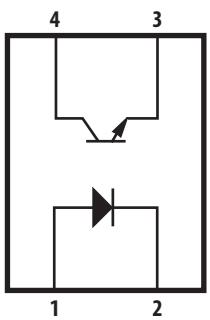
The HCPL-817 contains a light emitting diode optically coupled to a phototransistor. It is packaged in a 4-pin DIP package and available in wide-lead spacing option and lead bend SMD option. Input-output isolation voltage is 5000 Vrms. Response time, t_r, is typically 4 µs and minimum CTR is 50% at input current of 5 mA.

Schematic



Functional Diagram

PIN NO. AND INTERNAL CONNECTION DIAGRAM



1. ANODE
2. CATHODE
3. EMITTER
4. COLLECTOR

Features

- Current Transfer Ratio
  (CTR: min. 50% at I_F = 5 mA, V_{CE} = 5 V)
- High input-output isolation voltage (V_{iso} = 5000 V_{rms})
- Response time
  (tr: typ., 4 µs at VCE = 2 V, IC = 2 mA, RL = 100 Ω)
- Compact dual-in-line package
- UL approved
- CSA approved
- IEC/EN/DIN EN 60747-5-2 approved
- Options available:
  - Leads with 0.4" (10.16 mm) spacing (W00)
  - Leads bends for surface mounting (300)
  - Tape and reel for SMD (500)
  - IEC/EN/DIN EN 60747-5-2 approvals (060)

Applications

- Signal transmission between circuits of different potentials and impedances
- I/O interfaces for computers
- Feedback circuit in power supply

CAUTION: *It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD.*

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Ordering Information

HCPL-817-xxxx is UL Recognized with 5000 Vrms for 1 minute per UL1577 and is approved under CSA Component Acceptance Notice #5, File CA 88324.

	RoHS Compliant Option											
Part number	Rank '0' 50% <CTR< 600%	Rank 'A' 80% <CTR< 160%	Rank 'B' 130% <CTR< 260%	Rank 'C' 200% <CTR< 400%	Rank 'D' 300% <CTR< 600%	Rank 'L' 50% <CTR< 100%	Package	Surface Mount	Gull Wing	Tape & Reel	IEC/EN/ DIN EN 60747-5-2	Quantity
HCPL-817	-000E	-00AE	-00BE	-00CE	-00DE	-00LE	300mil DIP-4					100 pcs per tube
	-300E	-30AE	-30BE	-30CE	-30DE	-30LE		X	X			100 pcs per tube
	-500E	-50AE	-50BE	-50CE	-50DE	-50LE		X	X	X		1000 pcs per reel
	-060E	-06AE	-06BE	-06CE	-06DE	-06LE					X	100 pcs per tube
	-360E	-36AE	-36BE	-36CE	-36DE	-36LE		X	X		X	100 pcs per tube
	-560E	-56AE	-56BE	-56CE	-56DE	-56LE		X	X	X	X	1000 pcs per reel
	-W00E	-W0AE	-W0BE	-W0CE	-W0DE	-W0LE	400mil DIP-4					100 pcs per tube
	-W60E	-W6AE	-W6BE	-W6CE	-W6DE	-W6LE					X	100 pcs per tube

To order, choose a part number from the part number column and combine with the desired option from the option column to form an order entry.

Example 1:

HCPL-817-360E to order product of 300mil DIP-4 DC Gull Wing Surface Mount package in Tube packaging with 50%<CTR<600%, IEC/EN/DIN EN 60767-5-2 Safety Approval and RoHS compliant.

Example 2:

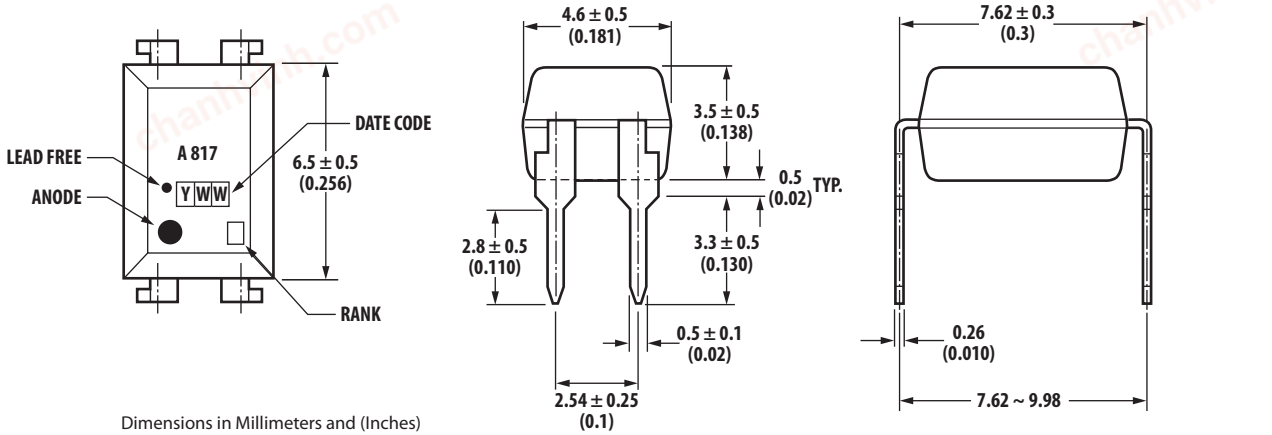
HCPL-817-50BE to order product of 300mil DIP-4 DC Gull Wing Surface Mount package in Tape and Reel packaging with 130%<CTR<260% and RoHS compliant.

Option datasheets are available. Contact your Avago sales representative or authorized distributor for information.

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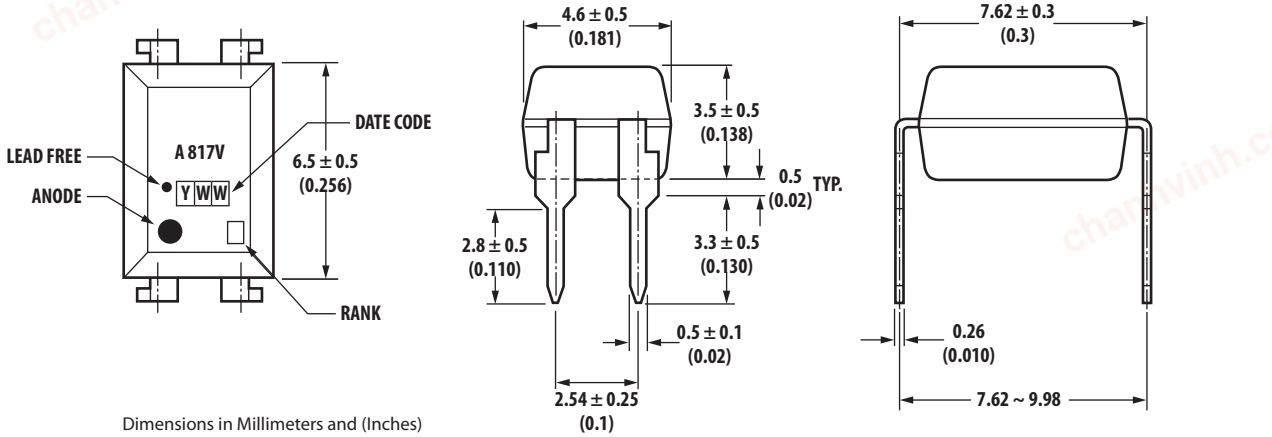
Package Outline Drawings

HCPL-817-000E



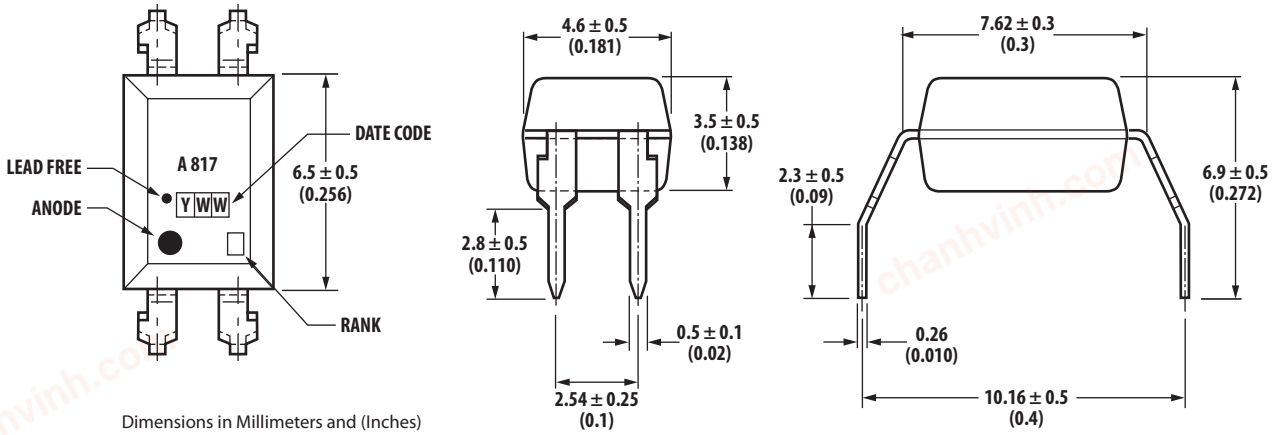
Dimensions in Millimeters and (Inches)

HCPL-817-060E



Dimensions in Millimeters and (Inches)

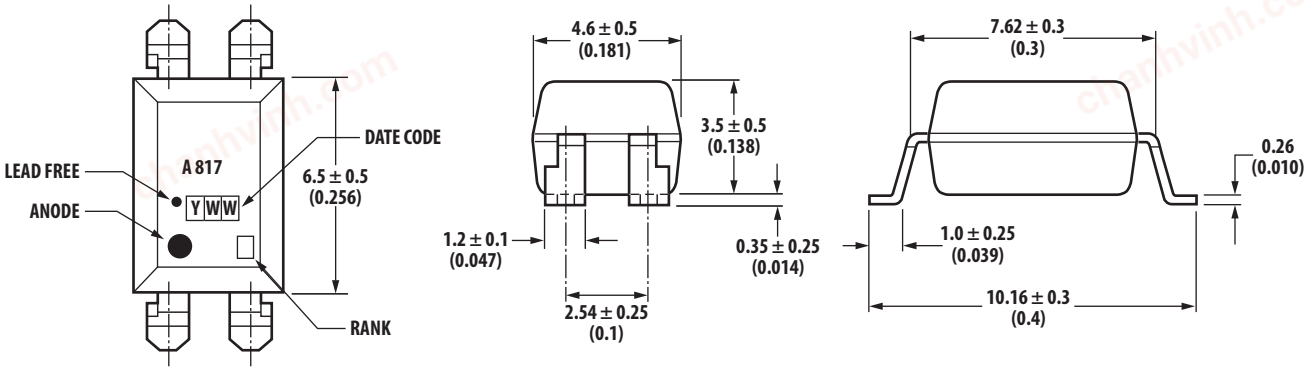
HCPL-817-W00E



Dimensions in Millimeters and (Inches)

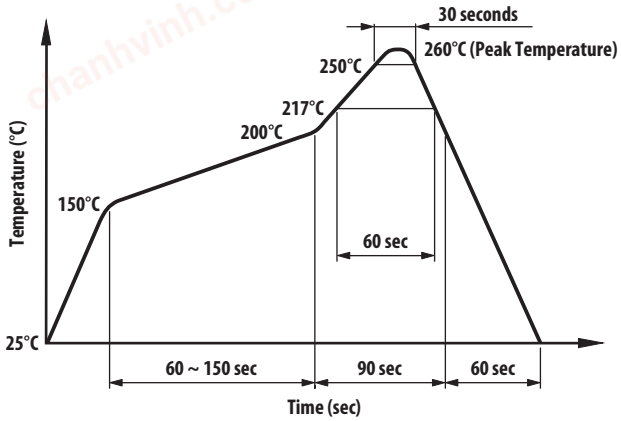
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HCPL-817-300E



Dimensions in Millimeters and (Inches)

Solder Reflow Temperature Profile



Note: Non-halide flux should be used.

1. One-time soldering reflow is recommended within the condition of temperature and time profile shown.
2. When using another soldering method such as infrared ray lamp, the temperature may rise partially in the mold of thedevice. Keep the temperature on the package of the device within the condition of (1) above.

Absolute Maximum Ratings (T_A = 25°C)

Storage Temperature, T_S	–55°C to +125°C
Operating Temperature, T_A	–30°C to +100°C
Lead Solder Temperature, max. (1.6 mm below seating plane)	260°C for 10 s
Average Forward Current, I_F	50 mA
Reverse Input Voltage, V_R	6 V
Input Power Dissipation, P_I	70 mW
Collector Current, I_C	50 mA
Collector-Emitter Voltage, V_{CEO}	70 V
Emitter-Collector Voltage, V_{ECO}	6 V
Collector Power Dissipation	150 mW
Total Power Dissipation	200 mW
Isolation Voltage, V_{iso} (AC for 1 minute, R.H. = 40 ~ 60%)	5000 Vrms

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Electrical Specifications ($T_A = 25°C$)

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Forward Voltage	V_F	–	1.2	1.4	V	$I_F = 20$ mA
Reverse Current	I_R	–	–	10	µA	$V_R = 4$ V
Terminal Capacitance	C_t	–	30	250	pF	V = 0, f = 1 KHz
Collector Dark Current	I_{CEO}	–	–	100	nA	$V_{CE} = 20$ V
Collector-Emitter Breakdown Voltage	BV_{CEO}	70	–	–	V	$I_C = 0.1$ mA
Emitter-Collector Breakdown Voltage	BV_{ECO}	6	–	–	V	$I_E = 10$ µA
Collector Current	I_C	2.5	–	30	mA	$I_F = 5$ mA, $V_{CE} = 5$ V, $R_{BE} = \infty$
*Current Transfer Ratio	CTR	50	–	600	%	
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	–	0.1	0.2	V	$I_F = 20$ mA, $I_C = 1$ mA
Response Time (Rise)	t_r	–	4	18	µs	$V_{CE} = 2$ V, $I_C = 2$ mA $R_L = 100\ \Omega$
Response Time (Fall)	t_f	–	3	18	µs	
Cut-off Frequency	f_c	–	80	–	KHz	$V_{CC} = 5$ V, $I_C = 2$ mA $R_L = 100\ \Omega$, –3 dB
Isolation Resistance	R_{iso}	5×10^{10}	1×10^{11}	–	Ω	DC 500 V 40 ~ 60% R.H.
Floating Capacitance	C_f	–	0.6	1.0	pF	V = 0, f = 1 MHz

$$* \text{CTR} = \frac{I_C}{I_F} \times 100\%$$

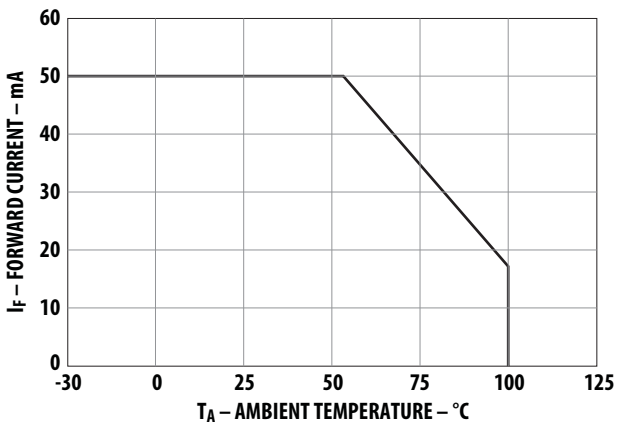


Figure 1. Forward current vs. temperature.

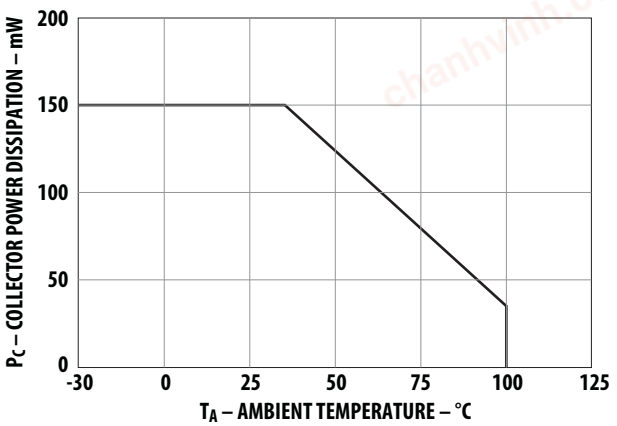


Figure 2. Collector power dissipation vs. temperature.

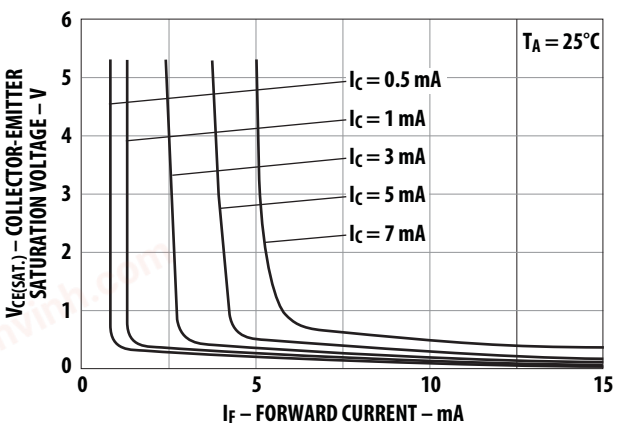


Figure 3. Collector-emitter saturation voltage vs. forward current.

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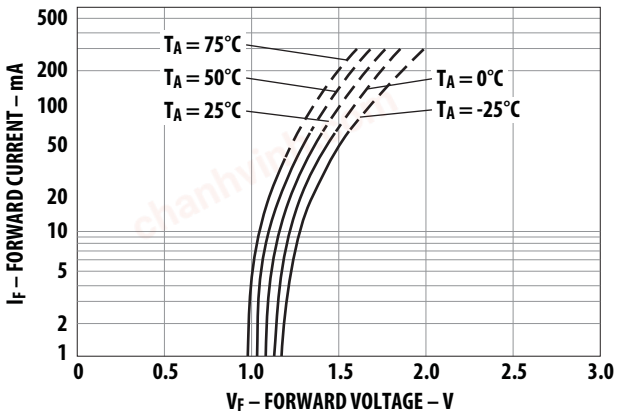


Figure 4. Forward current vs. forward voltage.

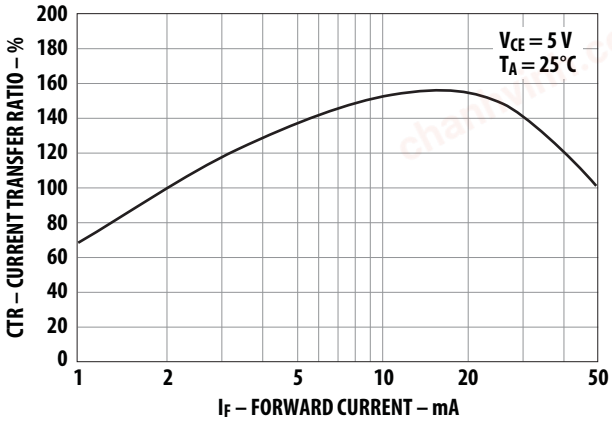


Figure 5. Current transfer ratio vs. forward current.

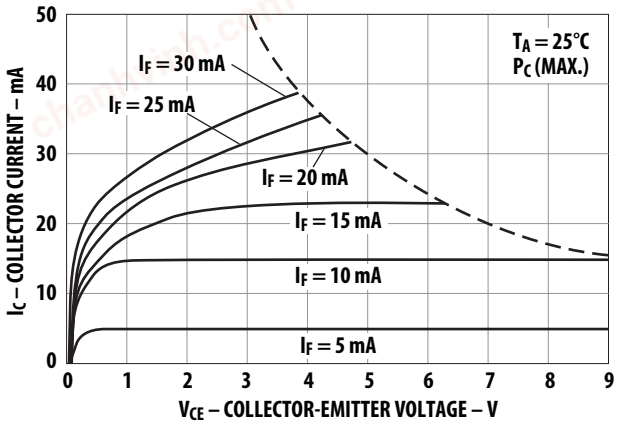


Figure 6. Collector current vs. collector-emitter voltage.

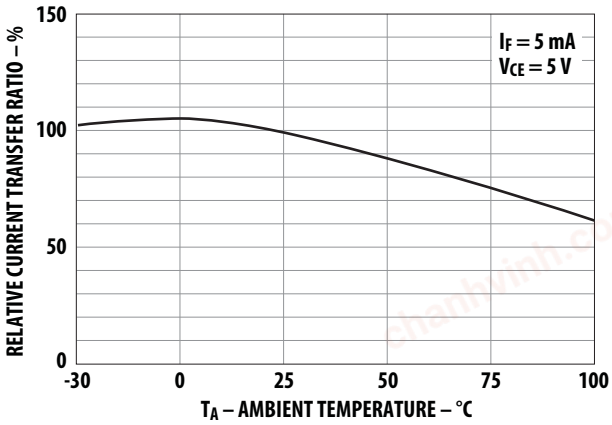


Figure 7. Relative current transfer ratio vs. temperature.

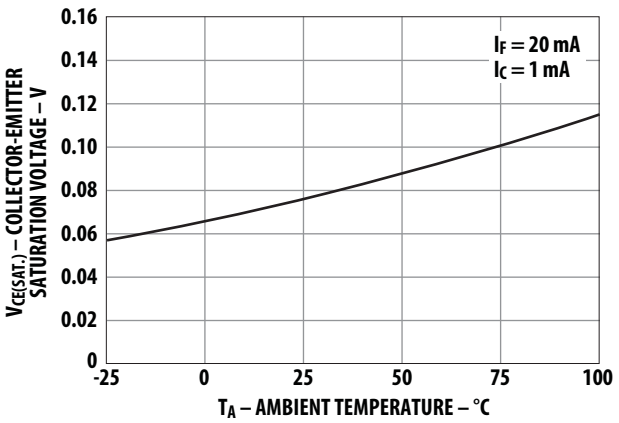


Figure 8. Collector-emitter saturation voltage vs. temperature.

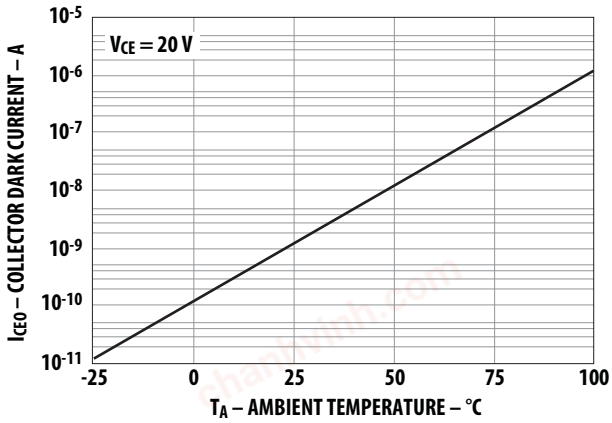


Figure 9. Collector dark current vs. temperature.

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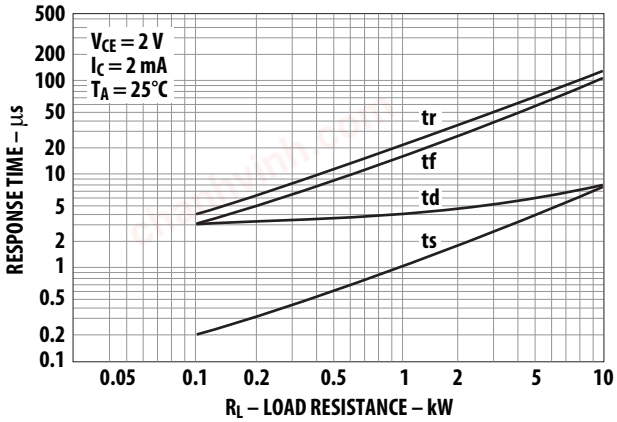


Figure 10. Response time vs. load resistance.

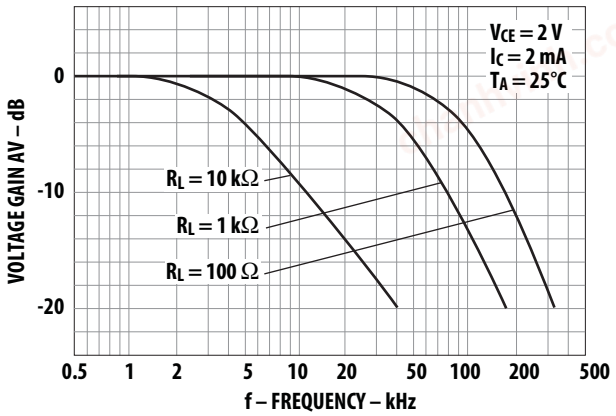
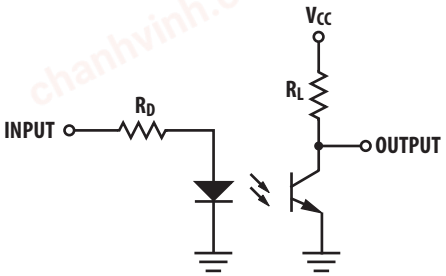
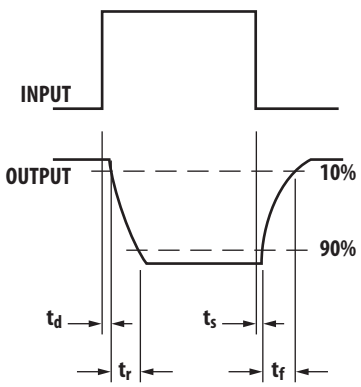


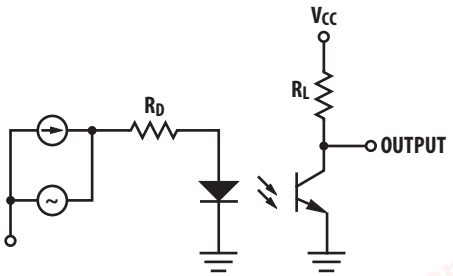
Figure 11. Frequency response.

Test Circuit for Response Time





Test Circuit for Frequency Response



For product information and a complete list of distributors, please go to our web site: **www.avagotech.com**

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